

BOXER-8251AI

Compact Fanless Embedded Al@Edge Box PC with NVIDIA® Jetson Xavier™ NX User's Manual 1st Ed

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Preface II

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Preface III

Packing List

Before setting up your product, please make sure the following items have been shipped:

Item		Quantity
•	BOXER-8251AI	1
•	Power Connector	1

If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

Preface IV

About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the product page at AAEON.com for the latest version of this document.

Preface V

Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

- 1. All cautions and warnings on the device should be noted.
- All cables and adapters supplied by AAEON are certified and in accordance with
 the material safety laws and regulations of the country of sale. Do not use any
 cables or adapters not supplied by AAEON to prevent system malfunction or
 fires.
- 3. Make sure the power source matches the power rating of the device.
- 4. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- 5. Always completely disconnect the power before working on the system's hardware.
- 6. No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
- 7. If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
- 8. Always disconnect this device from any AC supply before cleaning.
- 9. While cleaning, use a damp cloth instead of liquid or spray detergents.
- 10. Make sure the device is installed near a power outlet and is easily accessible.
- 11. Keep this device away from humidity.
- 12. Place the device on a solid surface during installation to prevent falls
- 13. Do not cover the openings on the device to ensure optimal heat dissipation.
- 14. Watch out for high temperatures when the system is running.
- 15. Do not touch the heat sink or heat spreader when the system is running
- 16. Never pour any liquid into the openings. This could cause fire or electric shock.

Preface VI

- 17. As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components.
 Use a grounding wrist strap and contain all electronic components in any static-shielded containers.
- 18. If any of the following situations arises, please the contact our service personnel:
 - i. Damaged power cord or plug
 - ii. Liquid intrusion to the device
 - iii. Exposure to moisture
 - iv. Device is not working as expected or in a manner as described in this manual
 - v. The device is dropped or damaged
 - vi. Any obvious signs of damage displayed on the device
- 19. DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.

Preface VII



This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

Preface VIII

产品中有毒有害物质或元素名称及含量

AAEON System

OO4-381 Rev.A2

	有毒有害物质或元素					
部件名称	铅	汞	镉	六价铬	多溴联苯	多溴二苯醚
	(Pb)	(Hg)	(Cd)	(Cr(VI))	(PBB)	(PBDE)
印刷电路板	×	0	C	0	0	0
及其电子组件	×	O))	0)
外部信号	×	0	C	0	C	0
连接器及线材	×	O)))
外壳	0	0	0	0	0	0
中央处理器	×	0	0	0	0	0
与内存	^	O)))
硬盘	×	0	0	0	0	0
液晶模块	×	0	0	0	0	0
光驱	×	0	0	0	0	0
触控模块	×	0	0	0	0	0
电源	×	0	0	0	0	0
电池	×	0	0	0	0	0

本表格依据 SJ/T 11364 的规定编制。

- 〇:表示该有毒有害物质在该部件所有均质材料中的含量均在 GB/T 26572 标准规定的限量要求以下。
- ×:表示该有害物质的某一均质材料超出了 GB/T 26572 的限量要求,然而该部件仍符合欧盟指令 2011/65/EU 的规范。

环保使用期限(EFUP (Environmental Friendly Use Period)): 10 年备注:

- 一、此产品所标示之环保使用期限,系指在一般正常使用状况下<mark>。</mark>
- 二、上述部件物质中央处理器、内存、硬盘、光驱、电源为选购品。
- 三、上述部件物质液晶模块、触控模块仅一体机产品适用。

Preface IX

China RoHS Requirement (EN)

Name and content of hazardous substances in product

AAEON System

QO4-381 Rev.A2

		Hazardous Substances					
Part Name	铅	汞	镉	六价铬	多溴联苯	多溴二苯醚	
	(Pb)	(Hg)	(Cd)	(Cr(VI))	(PBB)	(PBDE)	
PCB Assemblies	×	0	0	0	0	0	
Connector and		0	0	0	0)	
Cable	×	O	0	O	O	O	
Chassis	0	0	0	0	0	0	
CPU and Memory	×	0	0	0	0	0	
Hard Disk	×	0	0	0	0	0	
LCD Modules	×	0	0	0	0	0	
CD-ROM/DVD-ROM	×	0	0	0	0	0	
Touch Modules	×	0	0	0	0	0	
Power	×	0	0	0	0	0	
Battery	×	0	0	0	0	0	

The table is prepared in accordance with the provisions of SJ/T 11364.

- O: Indicates that said hazardous substance contained in all of the homogenous materials for this product is below the limit requirement of GB/T 26572.
- \times : Indicates that said hazardous substance contained in at least one of the homogenous materials used for this part is above the limit requirement of GB/T 26572. But this product still be compliance with 2011/65/EU Directive (allowed with 2011/65/EU Annex III of RoHS exemption with number 6(c),7(a),7(c)-1).

EFUP (Environment Friendly Use Period) value: 10 years.

Notes:

- 1. This product defined period of use is under normal condition.
- 2. In above part, CPU/Memory/ Hard Disk/CD-ROM/DVD-ROM/ Power are optional.
- 3. In above part, LCD Modules/ Touch Modules are for all-in-one product model.

Preface X

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Preface XII

Chapter 1

Product Specifications

1.1 Specifications

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CPU Six Core ARM® Carmel® V8.2 Processor

Chipset —

System Memory 8GB LPDDR4

Al Solution Nvidia Jetson Xavier NX

Display Interface HDMI 2.0

Storage Device 16GB eMMC

Micro SD Slot x1

Ethernet 10/100/1000Base-TX x 1

USB 3.2 Gen 1 x 4

I/O LAN x 1

RS-232 x 2

HDMI x 1

MicroSD x 1

DC Power Input x 1

Recovery Button x 1

Micro-USB for Flash OS x 1

Expansion M.2 E-Key 2230 x 1(for Wi-Fi)

Indicator Power LED x 1

OS Support Linux (AAEON ACLinux 4.9, Compliance with

Ubuntu 18.04)

Power Supply

Power Requirement 12Vdc w/ 2-pin terminal block

Mechanical

Mounting Wallmount

Dimensions (W x D x H) 3.46" x 2.95" x 1.53" (88mm x 75mm x 39mm)

Gross Weight 1.10 lbs. (0.5 kg)

Net Weight 0.66 lbs. (0.3 kg)

Environmental

Storage Temperature $-40^{\circ}\text{F} \sim 158^{\circ}\text{F} (-40^{\circ}\text{C} \sim 70^{\circ}\text{C})$

Storage Humidity 95% @ 40°C, non-condensing

Anti-Vibration 3 Grms/ 5 ~ 500Hz/ operation – MicroSD or

 eMMC

Certification CE/FCC class A

Operating temperature for the BOXER-8251AI is dependent system configuration for Power Mode and Active CPU Cores. The table below details maximum operating temperature without throttling for the system based on available configurations. Table is based on 100% CPU load, 100% GPU load, no throttling, and airflow of 0.5 m/sec.

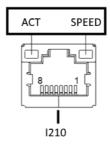
Operating Temperature					
Power Mode CPU Cores		CPU Maximum Frequency	Operating Temperature		
	6 Cores	1.4 GHz	-20°C ~ 40°C		
15W	4 Cores	1.4 GHz	-20°C ~ 40°C		
	2 Cores	1.9 GHz	-20°C ~ 50°C		
10W	4 Cores	1.2 GHz	-20°C ~ 50°C		
	2 Cores	1.5 GHz	-20°C ~ 50°C		

Micro-USB: Micro-USB port is ideally for flashing image only.

USB ports: USB ports do not support USB DVD ROM because of file system.

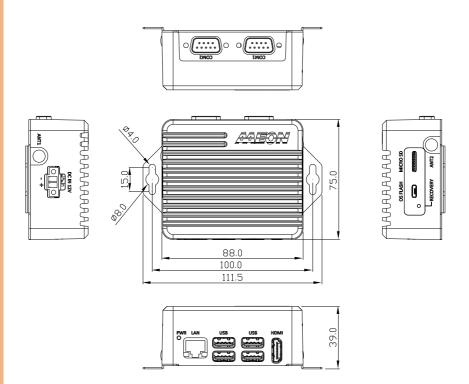
USB 3.2 Gen 1: USB 3.2 Gen 1 is the current name for 5Gbps specification, formerly USB 3.0.

LAN Indicator Behavior

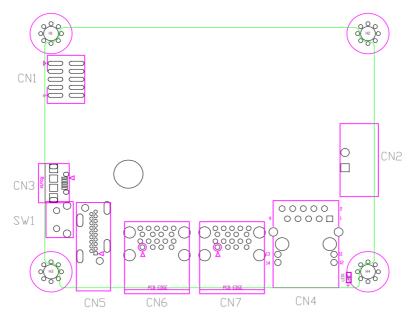


Chapter 2

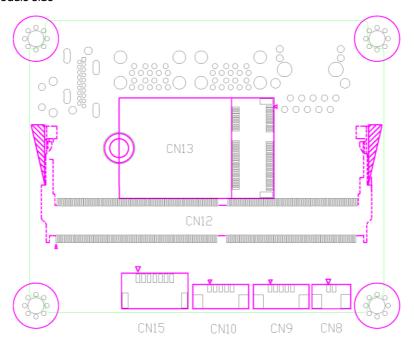
Hardware Information



Component Side



Module Side



2.3 List of Jumpers

The board has a number of jumpers that allow you to configure your system to suit your application.

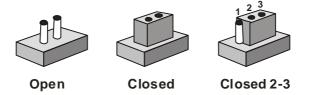
The table below shows the function of each of the board's jumpers

Label	Function
CN1 (Pin 7-8)	AT/ATX mode select

2.3.1 Setting Jumpers

You can configure your system to match the needs of your application by setting jumpers. A jumper is the simplest kind of electric switch. It consists of two metal pins and a small metal clip (often protected by a plastic cover) that slides over the pins to connect them. To "close" a jumper you connect the pins with the clip.

To "open" a jumper you remove the clip. Sometimes a jumper will have three pins, labeled 1, 2 and 3. In this case you would connect either pins 1 and 2 or 2 and 3.



A pair of needle-nose pliers may be helpful when working with jumpers.

If you have any questions about the best hardware configuration for your application, contact your local distributor or sales representative before you make any changes.

Generally, you simply need a standard cable to make most connections.

The AT/ATX Mode Select functions by connecting pins 7 and 8 of CN1. To prevent damage to the system, do not connect pins 7 and 8 to any other pin.



Open – AT Mode (Default)



Closed – ATX Mode

CN1 pins 7-8	Function	
7-8 Open	AT Power Mode (Default)	
7-8 Closed	ATX Power Mode	

2.4 List of Connectors

The board has a number of connectors that allow you to configure your system to suit your application.

The table below shows the function of each of the board's connectors

Label	Function
CN1	Front Panel Connector
CN2	DC Power In Connector
CN3	Micro USB for Flash image
CN4	Giga LAN Connector
CN5	HDMI Connector
CN6	Dual USB 3.2 Gen 1 Connector
CN7	Dual USB 3.2 Gen 1 Connector
CN8	RTC Connector
CN9	COM1 Connector /dev/ttyTHS1
CN10	COM2 Connector /dev/ttyTHS0
CN12	Jetson Xavier NX CPU module connector
CN13	M.2 E key
CN15	UART for Debug
SW1	Recovery switch

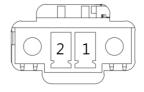
Note: USB 3.2 Gen 1 uses the same specifications as USB 3.0 (transfer rate 5Gbs).

1		2
3		4
5		6
7		8
9		10

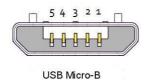
Pin	Signal	Pin	Signal
1	Button power	2	GND
3	Recovery	4	GND
5	Reset	6	GND
7	Latch set	8	Latch set
9	PWR LED	10	+5V

Note: Pin 7 and 8 are used for setting AT/ATX Power Mode. See **Chapter 2.3.2** for information. To prevent damage to your system, do not connect Pins 7 and 8 with any other pin.

2.4.2 DC Power In Connector (CN2)

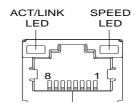


Pin	Signal	Pin	Signal
1	PWR_IN	2	GND

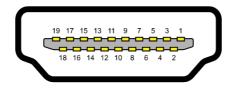


Pin	Signal	Pin	Signal
1		2	USB1-
3	USB1+	4	_
5	GND		

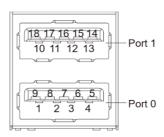
2.4.4 LAN RJ45 Port (CN4)



Pin	Signal	Pin	Signal
1	MDI0+	2	MDI0-
3	MDI1+	4	MDI1-
5	MDI2+	6	MDI2-
7	MDI3+	8	MDI3-



Pin	Signal	Pin	Signal
1	HDMI_DATA2_P	2	GND
3	HDMI_DATA2_N	4	HDMI_DATA1_P
5	GND	6	HDMI_DATA1_N
7	HDMI_DATA0_P	8	GND
9	HDMI_DATA0_N	10	HDMI_CLK_P
11	GND	12	HDMI_CLK_N
13	NC	14	NC
15	HDMI_SCL	16	HDMI_SDA
17	GND	18	HDMI_PWR
19	HDMI_HDP		



Pin	Signal	Pin	Signal
U1	VBUS_1	U10	VBUS_2
U2	(A)D-	U11	(B)D-
U3	(A)D+	U12	(B)D+
U4	GND	U13	GND
U5	(A)SSRX-	U14	(B)SSRX-
U6	(A)SSRX+	U15	(B)SSRX+
U7	GND	U16	GND
U8	(A)SSTX-	U17	(B)SSTX-
U9	(A)SSTX+	U18	(B)SSTX+

2.4.7 RTC Battery Connector (CN8)

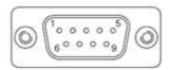


Pin	Signal	Pin	Signal	
1	+3V	2	GND	



Pin	RS-232	UART (3.3V)
1	TXD	
2	RXD	
3		UART TXD
4		UART RXD
5	GND	
6		
7		
8		
9		

2.4.9 COM Port Connector (System)

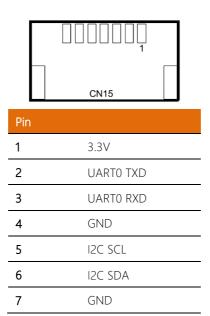


Pin	RS-232	UART (3.3V)
1		
2	RXD	
3	TXD	
4		

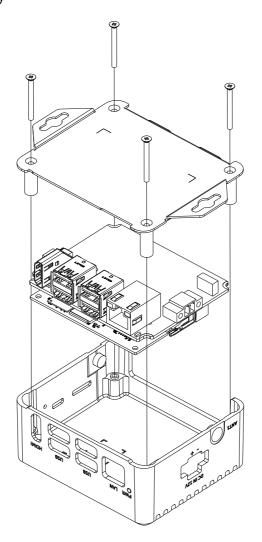
Pin	RS-232	UART (3.3V)
5	GND	
6		
7		UART RXD
8		UART TXD
9		

Module Signal Name	Pin#		Pin#	
GND	1		2	GND
CSI E DO P CSI E DO N	3 5		6	CSI B D0 N CSI B D0 P
GND	7		8	GND GND
CSI E CLK P	9		10	RSVD
CSI E CLK N	11		12	RSVD
GND	13		14	GND
CSI E D1 P	15		16	CSI B D1 P
CSI E D1 N	17		18	CSI B D1 N
GND CSI F D0 P	19 21		20 22	GND CSI A D0 P
CSI F D0 P	23		24	CSI A DO P
GND	25		26	GND
CSLF CLK P	27		28	CSI A CLK P
CSI F CLK N	29		30	CSI A CLK N
GND	31		32	GND
CSI F D1 P	33		34	CSI A D1 N
CSLF D1 N	35		36	CSI A D1 P
GND HDMI TXD0 N	37 39		38 40	GND CSI C D0 N
HDMI TXD0 N	41		42	CSI C DO N
GND	43		44	GND
HDMI TXC P	45		46	CSI C CLK N
HDMI TXC N	47		48	CSI C CLK P
GND	49		50	GND
HDMI TXD1 P	51		52	CSI C D1 P
HDMI TXD1 N	53		54	CSI C D1 N
GND HDMI TXD2 N	55 57		56 58	GND CSI D D0 P
HDMI TXD2 N	59		60	CSI D D0 P
GND	61		62	GND
EDP TXD1 N	63		64	CSI D D1 P
EDP TXD1 P	65		66	CSI D D1 N
GND	67		68	GND
EDP TXD3 N	69	\blacksquare	70	DSI A D1 N
EDP TXD3 P	71		72	DSI A D1 P
GND EDP TXD0 P	73 75		74 76	GND DSI A CLK N
EDP TXD0 N	77		78	DSI A CLK N
GND	79		80	GND
EDP TXD2 P	81		82	DSI A DO N
EDP TXD2 N	83		84	DSI A D0 P
GND	85		86	GND
USB VBUS ENO	87		88	HDMI INT DP HPD
SPI1 MOSI	89		90	HDMI CEC
SPI1 SCK SPI1 MISO	91 93		92 94	DP HPD DP AUX CH0 P
SPI1 CSO	95		96	DP AUX CHO N
SPI1 CS1	97		98	DP AUX CH1 N
UART3 TXD	99		100	DP AUX CH1 P
UART3 RTS	101		102	GND
UART3 CTS	103		104	SPI2 CS0
UART3 RXD	105	\vdash	106	SPI2 MISO
GND	107		108	SPI2 SCK
USBO DN USBO DP	109 111		110 112	SPI2 MOSI SPI2 CS1
GND	113		114	CAM2 PWDN
USB1 DN	115		116	CAM2 MCLK
USB1 DP	117		118	CAM AF EN
GND	119		120	CAM1 PWDN
USB2 DN	121		122	CAM1 MCLK
USB2 DP	123		124	GPIO PH6
GND	125		126	GPS EN
NFC INT GND	127 129		128 130	AP WAKE NFC NFC EN
PEX RX2 N	131		132	GND
I EN TIME IV			402	5.45

Module Signal Name	Pin#	Pin#	Module Signal Name
PEX RX2 P	133	134	PEX TX2 N
GND	135	136	PEX TX2 P
PEX RX1 N	137	138	GND
PEX RX1 P	139	140	PEX TX1 N
GND	141	142	PEX TX1 P
RSVD	143	144	GND
KEY	KEY	KEY	KEY
RSVD	145	146	GND
GND	147	148	PEX TX3 N
PEX RX3 P	149	150	PEX TX3 P
PEX RX3 N	151	152	GND
GND	153	154	PEX CLK1 N
PEX RX4 P	155	156	PEX CLK1 P
PEX RX4 N	157	158	GND
GND	159	160	PEX TX4 P
PEX RX6 N	161	162	PEX TX4 N
PEX RX6 P	163	164	GND
GND	165	166	PEX TX6 P
RSVD	167	168	PEX TX6 N
RSVD	169	170	GND
GND	171	172	RSVD
RSVD	173	174	RSVD
RSVD	175	176	GND
GND	177	178	MOD SLEEP*
PEX WAKE	179	180	PEX LO CLKREQ
PEX LO RST	181	182	RSVD
RSVD	183	184	GBE MDI3 P
GEN1 I2C SCL	185	186	GBE MDI3 N
GEN1 I2C SDA	187	188	GBE LED1
GEN2 I2C SCL	189	190	GBE MDI2 N
GEN2 I2C SDA	191	192	GBE MDI2 P
DAP4 DIN	193	194	GBE LEDO
DAP4 FS	195	196	GBE MDI1 N
DAP4 DOUT	197	198	GBE MDI1 P
DAP4 SCLK	199	200	GND
GND	201	202	GBE MDIO N
UART2 RTS UART2 CTS	203 205	204	GBE MDIO P LCD BL PWM
	207	206 208	
UART2 TXD UART2 RXD		210	GPIO PZ2 (FAN TACH) CLK 32K OUT
AUD MCLK	209	212	LCD BL EN
CAM I2C SCL	213	214	FORCE RECOVERY*
	215	216	GPIO PZ0
CAM I2C SDA GND	217	218	LCD TE
SDMMC3 DATO	219	220	DAP3 DOUT
SDMMC3 DAT1	221	222	DAP3 DIN
SDMMC3 DAT2	223	224	DAP3 BIN DAP3 FS
SDMMC3 DAT3	225	226	DAP3 FS DAP3 SCLK
SDMMC3 CMD	227	228	GPIO PE6
SDMMC3 CLK	229	230	GPIO PE7 (FAN PWM)
GND	231	232	GEN3 I2C SDA
SHUTDOWN REQ*	233	234	GEN3 I2C SCL
PMIC BBAT	235	236	UART1 TXD
POWER EN	237	238	UART1 RXD
SYS RESET IN*	239	240	BUTTON PWR ON*
GND	241	242	GND
GND	243	244	GND
GND	245	246	GND
GND	247	248	GND
GND	249	250	GND
VDD IN	251	252	VDD IN
VDD IN	253	254	VDD IN
VDD IN	255	256	VDD IN
VDD IN	257	258	VDD IN
VDD IN	259	260	VDD IN



Chassis Assembly



M.2 Module Installation

M.2 module attaches to the BOXER-8251AI board. NVIDIA Jetson Xavier NX module must be removed prior to installing M.2 module.



Chapter 3

OS Flash Guide

3.1 Before Installation

Before starting the process make sure your BOXER-8251AI system is turned off and the power in is disconnected. You will need a host PC running Ubuntu 16.04 or 18.04, and make sure the NVIDIA Jetson Xavier NX module is installed onto the BOXER-8251AI carrier board/ system.



Download the compressed OS image file. The file name will follow the format of:

$${\tt ACLinux_4.9_\{OS_IF\}.\{PLF_IF\}.\{PJ_IF\}.\{BN\}.tar.gz}$$

For example:

Note: Filename may differ from this example.

- I. {OS_IF} is OS Information. For example, ACLNX49D means ACLinux 4.9, Desktop version.
- II. {PLF_IF} is Platform Information; e.g. NV05
- III. {PJ_IF} is Project Information; e.g. **BOXER-8251AI**
- IV. {BN} is Build Number; e.g. 0, 1, 2, etc.

3.2 Force USB Recovery Mode

On Host Computer, open Linux terminal and enter the following command to extract compressed OS image files (*file name may vary*):

\$ tar -zxvf ACLinux 4.9 ACLNX49D.NV05.BOXER-8251AI.2.tar.gz

Next, perform the following steps to force the system to start in USB Recovery Mode:

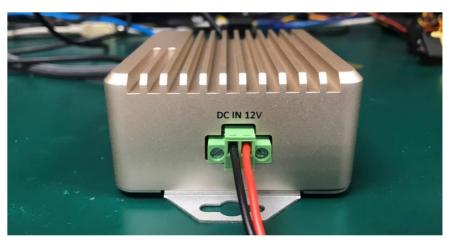
 Connect the Micro-USB plug on the USB cable to the Recovery Port on the BOXER-8251Al and the other end to an available USB port on the host PC.



2. Press and hold the FORCE RECOVERY button. FORCE RECOVERY button is highlighted in the following image:

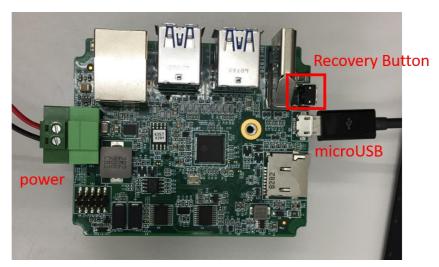


While holding the FORCE RECOVERY button, connect the power adapter.
 Continue to hold the FORCE RECOVERY button for two seconds, then release.



4. When device is in recovery mode, Isusb command on host PC will list a line of "0955:7e19 NVidia Corp"

Recovery mode can also be initiated with the system disassembled. Ensure the NVIDIA Jetson Xavier NX module is installed and refer to the image below to perform the steps:



3.2 Flash Image to Board

Use the following steps to flash the OS to the BOXER-8251AI.

- Open terminal on Linux host PC, then access the bootloader folder you extracted in the previous section.
- 2) Enter the following command in terminal to flash the image:

\$ sudo ./flashall.sh

3) Wait as the image is installed. Once finished you should see the following:

```
293.2436
303.9612
303.9665
306.1408
306.1458
              Writing partition bpmp-fw-dtb with tegra194-a02-bpmp-p3668-a00_sigheader.dtb.encrypt
            [.....] 100% Writing partition VER with qspi_bootblob_ver.txt
              Writing partition VER_b with qspi_bootblob_ver.txt
 308.3194
 308.3208
 308.3323
              [.....] 100 Writing partition master_boot_record with mbr_1_3.bin
 308.3342
  308.3448
              Writing partition APP with system.img
 308.3460
308.3520
               1182.8634
1182.8639
               [.....] 100%
Writing partition kernel_b with boot_sigheader.img.encrypt
[.....] 100%
Writing partition kernel-dtb with tegra194-p3668-all-p3509-0000_sigheader.dtb.encrypt
 1189.4815
1189.5005
 1191.1915
1191.2108
               [.....] 100%
Writing partition kernel-dtb_b with tegra194-p3668-all-p3509-0000_sigheader.dtb.encrypt
 1191.4403
1191.4504
                                                            .....] 100%
 1191.9762
1192.1310
               tegradevflash_v2 --write BCT br_bct_BR.bct
Bootloader version 01.00.0000
  1192.1320
  1192.6810
               Writing partition BCT with br_bct_BR.bct
 1192.6919
1192.9400
 1192.9972
1192.9984
               tegradevflash_v2 --write MB1_BCT mb1_cold_boot_bct_MB1_sigheader.bct.encrypt
               Bootloader version 01.00.0000
Writing partition MB1_BCT with mb1_cold_boot_bct_MB1_sigheader.bct.encrypt
  1193.5449
  1193.5455
  1194.1843
  1194.1856
               tegradevflash_v2 --write MB1_BCT_b mb1_cold_boot_bct_MB1_sigheader.bct.encrypt
 1194.1866
1194.7332
1194.7340
1195.1284
               Bootloader version 01.00.00000
Writing partition MB1_BCT_b with mb1_cold_boot_bct_MB1_sigheader.bct.encrypt
[......] 100%
 1195.1370
1195.1379
               tegradevflash_v2 --write MEM_BCT mem_coldboot_sigheader.bct.encrypt
               Bootloader version 01.00.0000
Writing partition MEM_BCT with mem_coldboot_sigheader.bct.encrypt
  1195.6850
  1195.6855
               [.....] 100%
  1198.2719
 1198.2730
1198.2738
               tegradevflash_v2 --write MEM_BCT_b mem_coldboot_sigheader.bct.encrypt
               Bootloader version 01.00.0000
 1198.8211
1198.8217
               Writing partition MEM_BCT_b with mem_coldboot_sigheader.bct.encrypt
               [.....] 100%
 1201.3157 ]
1201.3158 ] Flashing completed
 1201.3160 ]
1201.5699 ]
1202.8176 ]
1202.8199 ]
              Coldbooting the device
tegrarcm_v2 --ismb2
               tegradevflash_v2 --reboot coldboot
Bootloader version 01.00.0000
  1202.8221
 1203.3858
   The target t186ref has been flashed successfully. ***
Reset the board to boot from internal eMMC.
```